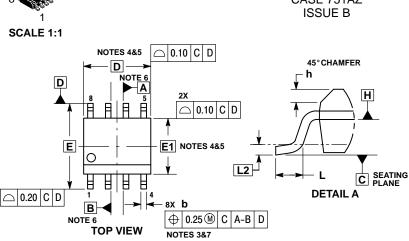
Α1

NOTE 8



△|0.10|C

C SEATING PLANE

SOIC-8 CASE 751AZ

DETAIL A

END VIEW

NOTE 7

C

DATE 18 MAY 2015

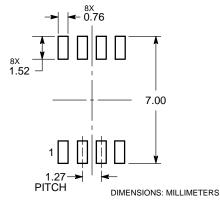
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.004 mm IN EXCESS OF MAXIMUM MATERIAL CONDITION.
- DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.006 mm PER SIDE. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.010 mm PER SIDE.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTER-MOST EXTREMES OF THE PLASTIC BODY AT DATUM H. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM H.
- 7. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 TO 0.25 FROM THE LEAD TIP.
- AT IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

	MILLIMETERS		
DIM	MIN	MAX	
Α	-	1.75	
A1	0.10	0.25	
A2	1.25		
b	0.31	0.51	
С	0.10	0.25	
D	4.90 BSC		
E	6.00 BSC		
E1	3.90 BSC		
е	1.27 BSC		
h	0.25	0.41	
L	0.40	1.27	
L2	0.25 BSC		

RECOMMENDED SOLDERING FOOTPRINT*

SIDE VIEW



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

Α = Assembly Location

= Wafer Lot L Υ = Year

W = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

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	ISSUE REVISION DATE			
ISSUE	ISSUE REVISION			
0	RELEASED FOR PRODUCTION FROM POD #6000209 TO ON SEMICONDUCTOR. REQ. BY B. BERGMAN.	19 SEP 2008		
А	CORRECTED DIMENSIONS NOTE FROM MILLIMETERS TO INCHES. REQ. BY J. LETTERMAN.	25 NOV 2014		
В	REDREW DRAWING TO JEDEC STANDARDS AND ADDED SOLDER FOOTPRINT. REQ. BY F. KOLANKO.	18 MAY 2015		

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